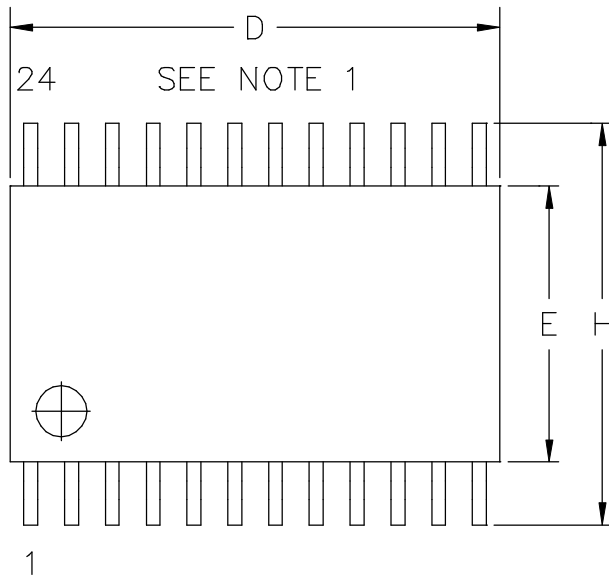
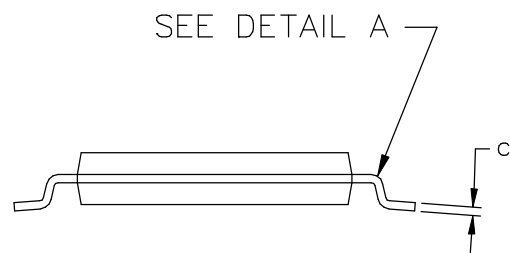
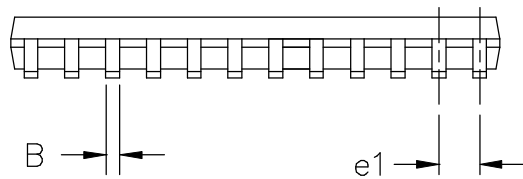


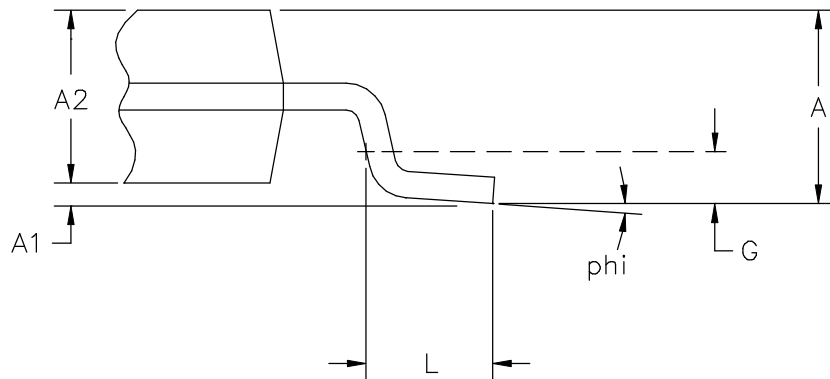


NOTES:

1. DIMENSION "D" INCLUDES MOLD MISSMATCH, FLASH, AND PROTRUSIONS.



DIM	MIN	MAX
A	—	1.10
A1	0.05	—
A2	0.75	1.05
c	0.09	0.18
phi	0°	8°
L	0.50	0.70
e1	0.65 BSC	
B	0.18	0.30
D	7.55	8.00
E	4.40 NOM	
G	0.25 REF	
H	6.25	6.55



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		 Dallas Semiconductor							
DOC. CONTROL:											
ENGR. MGR:				TITLE							
MFG. ENGR:				MARKETING OUTLINE, 24 LD. TSSOP, 4.4 MM BODY							
CHECKED BY:				SIZE		FSCM NO		PART NO.		REV	
DRAWN BY:				A						A	
DO NOT SCALE DWG.				SCALE N/A				SHEET 1 OF 1			